Patent CYPR-CD00199

AMENDMENT TO SPECIFICATION

Please replace the sentence beginning at page 6, line 16 with the following

replacement sentence:

-- Die 10 includes a plurality of wirebonding pads 14 (which are typically used for

providing a wirebond or soldered electrical connection to the integrated circuit 18--

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Serial No.: 09/893,050 Group Art Unit: 2111 Examiner: Mason, D. 3